SN74ALVCH16500 18-BIT UNIVERSAL BUS TRANSCEIVER WITH 3-STATE OUTPUTS

SCES023I-JULY 1995-REVISED OCTOBER 2004

FEATURES

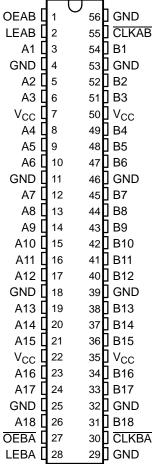
- Member of the Texas Instruments Widebus™
 Family
- EPIC[™] (Enhanced-Performance Implanted CMOS) Submicron Process
- UBT[™] (Universal Bus Transceiver) Combines
 D-Type Latches and D-Type Flip-Flops for
 Operation in Transparent, Latched, or Clocked
 Modes
- ESD Protection Exceeds 2000 V Per MIL-STD-883, Method 3015; Exceeds 200 V Using Machine Model (C = 200 pF, R = 0)
- Latch-UP Performance Exceeds 250 mA Per JESD 17
- Bus Hold on Data Inputs Eliminates the Need for External Pullup/Pulldown Resistors
- Package Options Include Plastic 300-mil Shrink Small-Outline (DL) and Thin Shrink Small-Outline (DGG) Packages

DESCRIPTION

This 18-bit universal bus transceiver is designed for 1.65-V to 3.6-V $V_{\rm CC}$ operation.

Data flow in each direction is controlled by output-enable (OEAB and \overline{OEBA}), latch-enable (LEAB and LEBA), and clock (\overline{CLKAB} and \overline{CLKBA}) inputs. For A-to-B data flow, the device operates in the transparent mode when LEAB is high. When LEAB is low, the A data is latched if \overline{CLKAB} is held at a high or low logic level. If LEAB is low, the A data is stored in the latch/flip-flop on the high-to-low transition of \overline{CLKAB} . Output-enable OEAB is active high. When OEAB is high, the B-port outputs are active. When OEAB is low, the B-port outputs are in the high-impedance state.

DGG OR DL PACKAGE (TOP VIEW)



Data flow for B to A is similar to that of A to B, but uses $\overline{\text{OEBA}}$, LEBA, and $\overline{\text{CLKBA}}$. The output enables are complementary (OEAB is active high, and $\overline{\text{OEBA}}$ is active low).

To ensure the high-impedance state during power up or power down, $\overline{\text{OEBA}}$ should be tied to V_{CC} through a pullup resistor, and OEAB should be tied to GND through a pulldown resistor; the minimum value of the resistor is determined by the current-sinking/current-sourcing capability of the driver.

Active bus-hold circuitry is provided to hold unused or floating data inputs at a valid logic level.

The SN74ALVCH16500 is characterized for operation from -40°C to 85°C.

Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

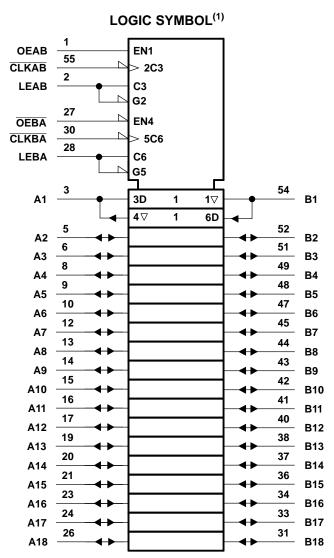
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FUNCTION TABLE(1)

	INP	UTS		OUTPUT
OEAB	LEAB	CLKAB	Α	В
L	Х	Χ	Χ	Z
Н	Н	Χ	L	L
Н	Н	Χ	Н	Н
Н	L	\downarrow	L	L
Н	L	\downarrow	Н	Н
Н	L	Н	Χ	B ₀ ⁽²⁾
Н	L	L	Χ	B ₀ ⁽²⁾ B ₀ ⁽³⁾

- A-to-B data flow is shown; B-to-A flow is similar but uses OEBA, LEBA, and CLKBA.
- (2) Output level before the indicated steady-state input conditions were established, provided that CLKAB was high before LEAB went low
- (3) Output level before the indicated steady-state input conditions were established

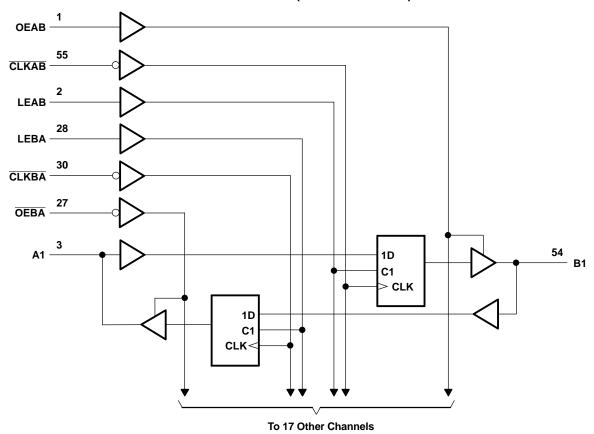


(1) This symbol is in accordance with ANSI/EEEE Std 91-1984 and IEC Publication 617-12.



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LOGIC DIAGRAM (POSITIVE LOGIC)



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ABSOLUTE MAXIMUM RATINGS(1)

over operating free-air temperature range (unless otherwise noted)

			MIN	MAX	UNIT
V_{CC}	Supply voltage range		-0.5	4.6	V
\/	Input voltage range	Except I/O ports ⁽²⁾	-0.5	4.6	V
VI	input voltage range	I/O ports ⁽²⁾⁽³⁾	-0.5	$V_{CC} + 0.5$	V
V_{O}	Output voltage range (2)(3)		-0.5	$V_{CC} + 0.5$	V
I_{IK}	Input clamp current	V ₁ < 0		-50	mA
I _{OK}	Output clamp current	V _O < 0		-50	mA
Io	Continuous output current			±50	mA
	Continuous current through each V_{CC} or	GND		±100	mA
0	Dockogo thormal impedance (4)	DGG package		64	°C/W
θ_{JA}	Package thermal impedance (4)	DL package		56	C/VV
T _{stg}	Storage temperature range	torage temperature range			

⁽¹⁾ Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

RECOMMENDED OPERATING CONDITIONS(1)

			MIN	MAX	UNIT
V_{CC}	Supply voltage		1.65	3.6	V
		V _{CC} = 1.65 V to 1.95 V	$0.65 \times V_{CC}$		
V_{IH}	High-level input voltage	$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	1.7		V
		$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$	2		
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$		$0.35 \times V_{CC}$	
V_{IL}	Low-level input voltage	$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		0.7	V
		$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$		0.8	
VI	Input voltage	·	0	V _{CC}	V
Vo	Output voltage		0	V _{CC}	V
		V _{CC} = 1.65 V		-4	
	High lovel output ourrent	$V_{CC} = 2.3 \text{ V}$		-12	A
I _{OH}	High-level output current	$V_{CC} = 2.7 \text{ V}$		-12	mA
		V _{CC} = 3 V		-24	
		V _{CC} = 1.65 V		4	
	Low lovel output ourrent	V _{CC} = 2.3 V		12	mA
I _{OL}	Low-level output current	V _{CC} = 2.7 V		12	mA
		V _{CC} = 3 V		24	
Δt/Δν	Input transition rise or fall rate			10	ns/V
T _A	Operating free-air temperature		-40	85	°C

⁽¹⁾ All unused control inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

⁽²⁾ The input negative-voltage and output voltage ratings may be exceeded if the input and output current ratings are observed.

³⁾ This value is limited to 4.6 V maximum.

⁽⁴⁾ The package thermal impedance is calculated in accordance with JESD 51.



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ELECTRICAL CHARACTERISTICS

over recommended operating free-air temperature range (unless otherwise noted)

PAR	AMETER	TEST CO	ONDITIONS	V _{cc}	MIN	TYP ⁽¹⁾	MAX	UNIT			
		I _{OH} = -100 μA		1.65 V to 3.6 V	V _{CC} - 0.2						
		I _{OH} = -4 mA		1.65 V	1.2						
		I _{OH} = -6 mA		2.3 V	2						
V_{OH}				2.3 V	1.7			V			
		$I_{OH} = -12 \text{ mA}$		2.7 V	2.2						
				3 V	2.4						
		I _{OH} = -24 mA		3 V	2						
		I_{OL} = 100 μ A		1.65 V to 3.6 V			0.2				
		I _{OL} = 4 mA		1.65 V			0.45				
.,		I _{OL} = 6 mA		2.3 V			0.4	\/			
V _{OL}		l - 12 mΛ		2.3 V			0.7	V			
		I _{OL} = 12 mA		2.7 V			0.4				
		$I_{OL} = 24 \text{ mA}$		3 V			0.55				
I		$V_I = V_{CC}$ or GND		3.6 V			±5	μΑ			
		$V_I = 0.58 \text{ V}$		1.65 V	25						
		V _I = 1.07 V		1.65 V	-25						
		$V_I = 0.7 V$		2.3 V	45						
I _{I(hold)}		$V_I = 1.7 V$		2.3 V	-45			μΑ			
		V _I = 0.8 V		3 V	75						
		V _I = 2 V		3 V	-75						
		V _I = 0 to 3.6 V ⁽²⁾		3.6 V			±500				
I _{OZ} (3)		$V_O = V_{CC}$ or GND		3.6 V			±10	μΑ			
I _{CC}		$V_I = V_{CC}$ or GND,	I _O = 0	3.6 V			40	μΑ			
ΔI_{CC}		One input at V _{CC} - 0.6 V,	Other inputs at V _{CC} or GND	3 V to 3.6 V			750	μΑ			
C _i C	Control inputs	V _I = V _{CC} or GND		3.3 V		4		pF			
C _{io} A	A or B ports	V _O = V _{CC} or GND		3.3 V		8		pF			

⁽¹⁾ All typical values are at $V_{CC} = 3.3 \text{ V}$, $T_A = 25^{\circ}\text{C}$. (2) This is the bus-hold maximum dynamic current. It is the minimum overdrive current required to switch the input from one state to

For I/O ports, the parameter I_{OZ} includes the input leakage current.

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TIMING REQUIREMENTS

over recommended operating free-air temperature range (unless otherwise noted) (see Figure 1 through Figure 3)

				V _{CC} =	V _{CC} = 1.8 V		V _{CC} = 2.5 V ± 0.2 V		V _{CC} = 2.7 V		V_{CC} = 3.3 V \pm 0.3 V	
				MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
f _{clock}	Clock frequency				(1)		150		150		150	MHz
	Pulse duration	LE high		(1)		3.3		3.3		3.3		20
t _w	Pulse duration	CLK high or low		(1)		3.3		3.3		3.3		ns
		Data before CLK ↓				1.7		1.4		1.3		
t _{su}	Setup time	Data hatana LEL	CLK high	(1)		1.1		1		1		ns
		Data before LE↓	CLK low	(1)		1.9		1.6		1.4		
		Data after CLK↓		(1)		1.7		1.6		1.3		
t _h	Hold time	Data after LE↓	CLK high	(1)		2		1.8		1.5		ns
		Data after LEV	CLK low	(1)		1.6		1.5		1.2		

⁽¹⁾ This information was not available at the time of publication.

SWITCHING CHARACTERISTICS

over recommended operating free-air temperature range (unless otherwise noted) (see Figure 1 through Figure 3)

PARAMETER	FROM	TO (OUTBUT)	V _{CC} = 1.8 V		V _{CC} = 2.5 V ± 0.2 V		V _{CC} = 2.7 V		V_{CC} = 3.3 V \pm 0.3 V		UNIT
	(INPUT)	(OUTPUT)	MIN	TYP	MIN	MAX	MIN	MAX	MIN	MAX	
f _{max}			(1)		150		150		150		MHz
	A or B	B or A		(1)	1	5.1		4.7	1	3.9	
t _{pd}	LEAB or LEBA	A or B		(1)	1	5.9		5.5	1	4.7	ns
	CLKAB or CLKBA	AUID		(1)	1	6.6		6.6	1.1	5.5	
t _{en}	OEAB	В		(1)	1	5.7		5.4	1	4.6	ns
t _{dis}	OEAB	В		(1)	1	6.1		5.7	1.5	5	ns
t _{en}	OEBA	Α		(1)	1	6.2		6.2	1	5.2	ns
t _{dis}	OEBA	А		(1)	1	5.4	·	4.6	1	4.3	ns

⁽¹⁾ This information was not available at the time of publication.

OPERATING CHARACTERISTICS

 $T_A = 25^{\circ}C$

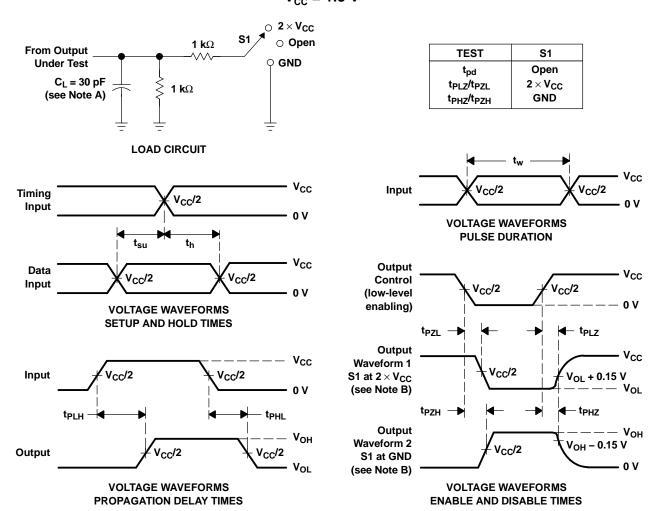
	PARAMETE	R	TEST CONDITIONS	V _{CC} = 1.8 V TYP	V _{CC} = 2.5 V TYP	V _{CC} = 3.3 V TYP	UNIT
0	Power dissipation	Outputs enabled	C _ 50 pE f _ 10 MHz	(1)	40	51	pF
Cpd	capacitance	Outputs disabled	$C_L = 50 \text{ pF, f} = 10 \text{ MHz}$	(1)	6	6	рг

⁽¹⁾ This information was not available at the time of publication.





PARAMETER MEASUREMENT INFORMATION $V_{cc} = 1.8 \text{ V}$



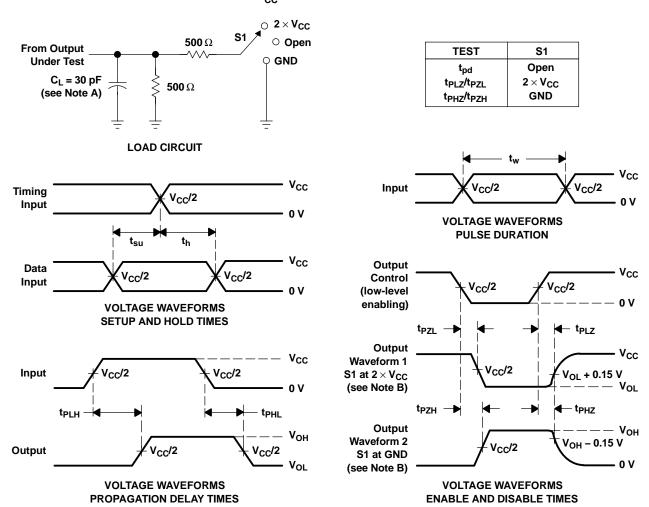
NOTES: A. C₁ includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, Z $_{O}$ = 50 Ω , t_{f} \leq 2 ns, t_{f} \leq 2 ns.
- D. The outputs are measured one at a time, with one transition per measurement.
- E. t_{Pl 7} and t_{PH7} are the same as t_{dis}.
- F. t_{PZL} and t_{PZH} are the same as t_{en}.
- G. t_{PLH} and t_{PHL} are the same as t_{pd}.

Figure 1. Load Circuit and Voltage Waveforms



PARAMETER MEASUREMENT INFORMATION V_{cc} = 2.5 V \pm 0.2 V



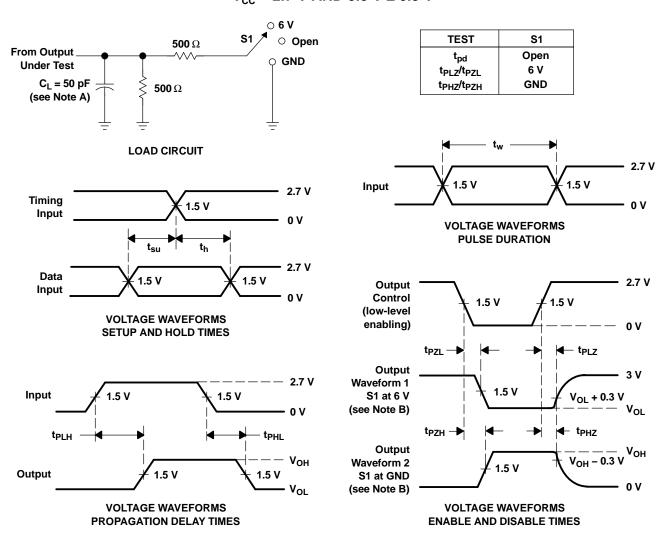
NOTES: A. C_I includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, $Z_O = 50~\Omega$, $t_f \leq$ 2 ns.
- D. The outputs are measured one at a time, with one transition per measurement.
- E. t_{PL7} and t_{PH7} are the same as t_{dis}.
- F. t_{PZL} and t_{PZH} are the same as t_{en}.
- G. t_{PLH} and t_{PHL} are the same as t_{pd}.

Figure 2. Load Circuit and Voltage Waveforms



PARAMETER MEASUREMENT INFORMATION V_{CC} = 2.7 V AND 3.3 V \pm 0.3 V



- NOTES: A. C_L includes probe and jig capacitance.
 - B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
 - C. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, Z_{O} = 50 Ω , $t_{r} \leq$ 2.5 ns, $t_{f} \leq$ 2.5 ns.
 - D. The outputs are measured one at a time, with one transition per measurement.
 - E. t_{PLZ} and t_{PHZ} are the same as t_{dis}.
 - F. t_{PZL} and t_{PZH} are the same as t_{en}.
 - G. t_{PLH} and t_{PHL} are the same as t_{pd}.

Figure 3. Load Circuit and Voltage Waveforms

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PACKAGING INFORMATION

Orderable part number	Status (1)	Material type	Package Pins	Package qty Carrier	RoHS (3)	Lead finish/ Ball material	MSL rating/ Peak reflow	Op temp (°C)	Part marking (6)
SN74ALVCH16500DLR	Active	Production	SSOP (DL) 56	1000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	ALVCH16500
SN74ALVCH16500DLR.B	Active	Production	SSOP (DL) 56	1000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	ALVCH16500

⁽¹⁾ Status: For more details on status, see our product life cycle.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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⁽²⁾ Material type: When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

⁽³⁾ RoHS values: Yes, No, RoHS Exempt. See the TI RoHS Statement for additional information and value definition.

⁽⁴⁾ Lead finish/Ball material: Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

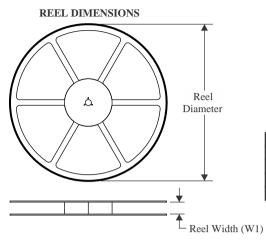
⁽⁵⁾ MSL rating/Peak reflow: The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

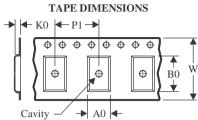
⁽⁶⁾ Part marking: There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

PACKAGE MATERIALS INFORMATION

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TAPE AND REEL INFORMATION





	-
A0	Dimension designed to accommodate the component width
В0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	` '	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74ALVCH16500DLR	SSOP	DL	56	1000	330.0	32.4	11.35	18.67	3.1	16.0	32.0	Q1

PACKAGE MATERIALS INFORMATION

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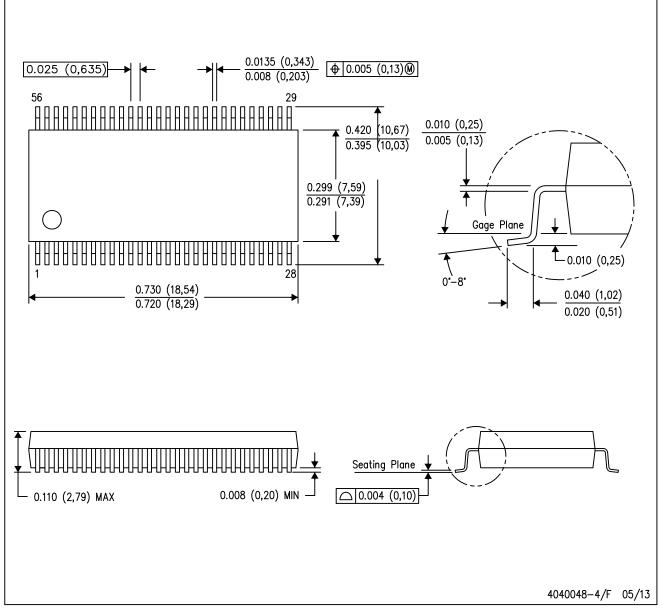


*All dimensions are nominal

Ì	Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
ı	SN74ALVCH16500DLR	SSOP	DL	56	1000	356.0	356.0	53.0

DL (R-PDSO-G56)

PLASTIC SMALL-OUTLINE PACKAGE



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
- D. Falls within JEDEC MO-118

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